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**NTE2382**  
**MOSFET**  
**N-Channel Enhancement Mode,**  
**High Speed Switch**  
**(Compl to NTE2383)**

**Description:**

The NTE2382 is a MOS power N-Channel FET in a TO220 type package designed for high voltage, high speed power switching applications such as switching regulators, converters, solenoid, and relay drivers.

**Features:**

- Lower  $R_{DS(ON)}$
- Improved Inductive Ruggedness
- Fast Switching Times
- Rugged Polysilicon Gate Cell Structure
- Lower Input Capacitance
- Extended Safe Operating Area
- Improved High Temperature Reliability

**Absolute Maximim Ratings:**

Drain–Source Voltage (Note 1), $V_{DSS}$ .....	100V
Drain–Gate Voltage ( $R_{GS} = 1M\Omega$ , Note 1), $V_{DGR}$ .....	100V
Gate–Source Voltage, $V_{GS}$ .....	$\pm 20V$
Continuous Drain Current, $I_D$	
$T_C = +25^\circ C$ .....	9.2A
$T_C = +100^\circ C$ .....	6.5A
Drain Current, Pulsed (Note 3), $I_{DM}$ .....	37A
Gate Current, Pulsed, $I_{GM}$ .....	$\pm 1.5A$
Single Pulsed Avalanche Energy (Note 4), $E_{AS}$ .....	36mJ
Avalanche Current, $I_{AS}$ .....	9.2A
Total Power Dissipation ( $T_C = +25^\circ C$ ), $P_D$ .....	50W
Derate Above $25^\circ C$ .....	$0.4W/^\circ C$
Operating Junction Temperature Range, $T_{opr}$ .....	$-55^\circ$ to $+150^\circ C$
Storage Temperature Range, $T_{stg}$ .....	$-55^\circ$ to $+150^\circ C$
Thermal Resistance, Junction-to-Ambient, $R_{thJA}$ .....	$62.5^\circ C/W$
Thermal Resistance, Junction-to-Case, $R_{thJC}$ .....	$2.5^\circ C/W$
Thermal Resistance, Case-to-Sink (Note 5), $R_{thCS}$ .....	$0.5^\circ C/W$
Maximum Lead Temperature (During Soldering, 1/8" from case, 5sec), $T_L$ .....	$+300^\circ C$

Note 1.  $T_J = +25^\circ$  to  $+150^\circ C$

Note 2. Pulse Test: Pulse Width  $\leq 300\mu s$ , Duty Cycle  $\leq 2\%$ .

Note 3. Repetitive rating: Pulse width limited by max. junction temperature.

Note 4.  $L = 64mH$ ,  $V_{DD} = 25V$ ,  $R_G = 25\Omega$ , Starting  $T_J = +25^\circ C$ .

Note 5. Mounting surface flat, smooth, and greased.

**Electrical Characteristics:** ( $T_C = +25^\circ\text{C}$  unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain–Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{GS} = 0, I_D = 0.25\text{mA}$	100	—	—	V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{DS} = 100\text{V}, V_{GS} = 0$	—	—	0.25	mA
		$V_{DS} = 80\text{V}, V_{GS} = 0, T_J = +125^\circ\text{C}$	—	—	1.0	mA
Gate–Body Leakage Current, Forward	$I_{GSS}$	$V_{GS} = 20\text{V}$	—	—	100	nA
Gate–Body Leakage Current, Reverse	$I_{GSS}$	$V_{GS} = 20\text{V}$	—	—	-100	nA
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = 0.25\text{mA}$	2.0	—	4.0	V
Static Drain–Source On–Resistance	$r_{DS(\text{on})}$	$V_{GS} = 10\text{V}, I_D = 4.6\text{A}$ , Note 2	—	—	0.27	$\Omega$
Forward Transconductance	$g_{FS}$	$V_{DS} \geq 50\text{V}, I_D = 4.6\text{A}$ , Note 2	2.7	4.1	—	mhos
Input Capacitance	$C_{iss}$	$V_{DS} = 25\text{V}, V_{GS} = 0, f = 1\text{MHz}$	—	400	—	pF
Output Capacitance	$C_{oss}$		—	130	—	pF
Reverse Transfer Capacitance	$C_{rss}$		—	40	—	pF
Turn–On Delay Time	$t_{d(\text{on})}$	$V_{DD} = 50\text{V}, I_D = 9.2\text{A}, Z_O = 18\Omega$ , MOSFET switching times are essentially independent of operating temperature	—	8.8	13.0	ns
Rise Time	$t_r$		—	30	45	ns
Turn–Off Delay Time	$t_{d(\text{off})}$		—	19	27	ns
Fall Time	$t_f$		—	20	30	ns
Total Gate Charge	$Q_g$	$V_{GS} = 10\text{V}, V_{DS} = 80\text{V}, I_D = 9.2\text{A}$ , Gate charge is essentially independent of operating temperature	—	—	23	nC
Gate–Source Charge	$Q_{gs}$		—	4.6	—	nC
Gate–Drain (“Miller”) Charge	$Q_{gd}$		—	9.1	—	ns
<b>Source–Drain Diode Ratings and Characteristics</b>						
Continuous Source Current (Body Diode)	$I_S$		—	—	9.2	A
Pulse Source Current (Body Diode)	$I_{SM}$	Note 3	—	—	37	A
Diode Forward Voltage	$V_{SD}$	$T_J = +25^\circ\text{C}, I_S = 9.2\text{A}, V_{GS} = 0\text{V}$ , Note 2	—	—	2.5	V
Reverse Recovery Time	$t_{rr}$	$T_J = +25^\circ\text{C}, I_F = 9.2\text{A}$ , $dI_F/dt = 100\text{A}/\mu\text{s}$	—	110	240	ns

Note 2. Pulse Test: Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$ .

Note 3. Repetitive rating: Pulse width limited by max. junction temperature.

